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501.36931CX2

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): T. Iwasaki, et al.  
Application. No. 09/255,856  
Filed: February 23, 1999  
For: SEMICONDUCTOR DEVICE WITH LAYERED  
INTERCONNECT STRUCTURE  
Group: 2813  
Examiner: S. Smoot

**NOTICE OF APPEAL FROM THE PRIMARY**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

November 23, 2004

Sir:

In accordance with the provisions of 37 CFR 1.191, Applicants hereby appeal from the final rejection as set forth in the Final Office Action mailed June 23, 2004, finally rejecting claims 4, 9, 10, 16-20, 22-25, 27-31 and 33-37.

A Credit Card Payment form in the amount of \$340.00 is enclosed, to cover the Appeal Fee.

Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

*William I. Solomon*  
William I. Solomon  
Registration No. 28,565

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